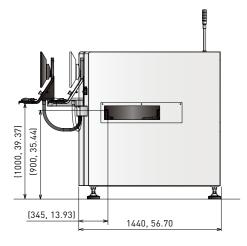
Dimensions

■ Front View (mm, in.)



■ Side View (mm, in.)



Model Name	2Di-LU1
Resolution	18 µm
Target PCB Size mm (in.)	Carrier: 50 W x 60 L - 610 W x 610 L mm (1.97 W x 2.36 L -24.02 W x 24.02 L in.) Inspection area (Scan): 50 W x 60 L - 460 W x 500 L mm (1.97 W x 2.36 L -18.11 W x 19.69 L in.)
PCB Thickness	0.5 - 5.2 mm (0.02-0.20 in.)
PCB Weight	12 kg (26.46 lbs) or less
PCB Clearance	Top: 130 mm (5.12 in.), Bottom: 40 mm (1.57 in.)
Heat Resistant Temperature	70°C (158F) or lower
Inspection Categories	Solder inspection for THT (Copper, Blow Hol Pin, Fillet, Absence of Solder, Bridge) *Each defect name can be arranged freely b the system function
Transfer Conveyor Method	Flat belt transfer
Transfer Conveyor Height	880 - 965 mm (34.65 - 37.99 in.)
Operating System	Windows 10 IoT Enterprise 64 bit English Editon (Microsoft)
Electric Power Requirement	~ 200 - 240V +/-10%, 50/60Hz, 700VA
Air Requirement	0.5MPa, 5L/min (ANR)
Usage Environment	15°C (59F) - 30°C (86F) / 15 - 80% RH (Non-condensing)
Dimensions W x D x H(Main body)	1040 x 1440 x 1500 mm (40.94 × 56.69 × 59.06 in.)
Weight	Approx. 750 kg, 1653.47 lbs

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Global Network

https://www.sakicorp.com/en/



Inline Bottom-side 2D Automated

Back-end inline solution after selective

Optical Inspection System

2Di-LU1

and wave soldering



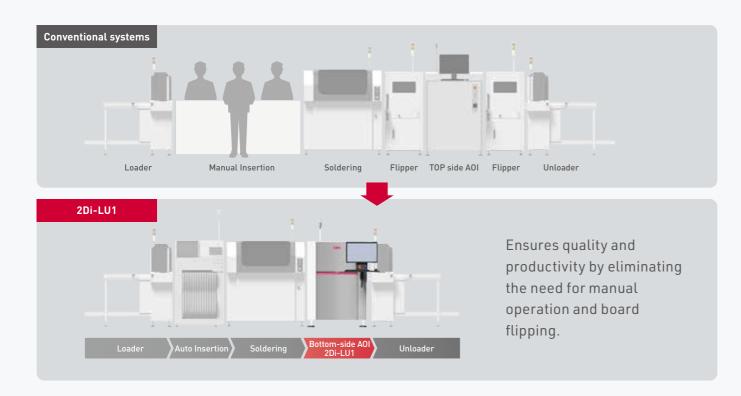
Bottom-side automated inspection machine for PCB back-end production

Ensuring the quality of through-hole solder parts after dip, selective, and wave soldering, and improving productivity.

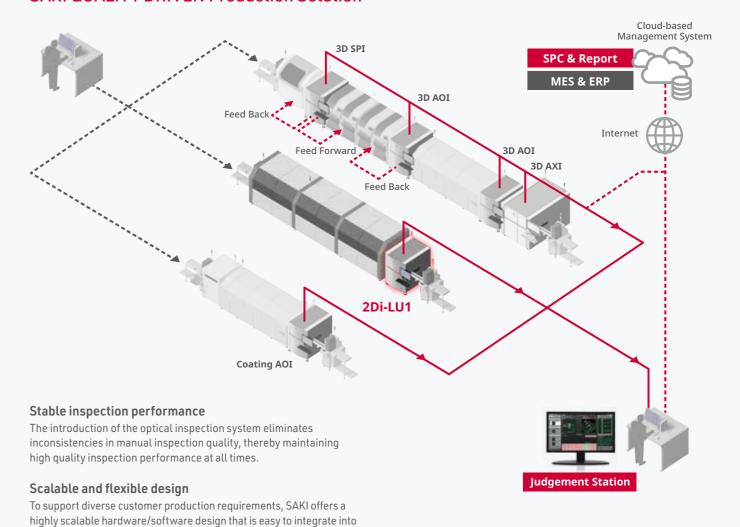
Bottom-scan AOI system for automated PCB back-end production.

Ensure full traceability and Quality Assurance Data availability for back-end production.

Prevent damage from manual or automated board handling by eliminating the need to flip the PCBs.



SAKI QUALITY DRIVEN Production Solution



Factor 1

SAKI's Proprietary Hardware

SAKI Line Scan technology

SAKI's unique Line Scan imaging technology is applied to bottom-side inspection. High-speed imaging enables inspection of large PCBs in one pass in about 9 seconds. The newly developed high-rigidity conveyor is compatible with large odd-shaped inserted component mounted-PCBs and heavy jigs. Covering the scanner with tempered glass protects it against falling flux and foreign substances. It provides easy maintenance and cleaning.

- Maximum PCB size 460 x 500 mm (18.11 x 19.69 in.)
- Maximum PCB weight 12 kg (26.46 lbs)
- PCB clearance Top: 130 mm (5.12 in.), Bottom: 40 mm (1.57 in.)

Bottom-side scanning



Factor 2

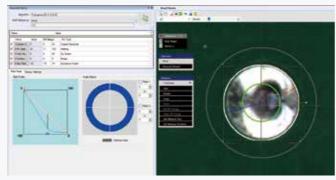
SAKI's Unique Software

Proven inspection algorithms

The highly rated FUJIYAMA algorithm provides through-hole solder joint and pin inspection. By analyzing solder meniscus and pin presence using SAKI's unique lighting technology, the following defects are simultaneously inspected:

- Copper exposure Excessive solder
- Pin presence
- Insufficient solder
- Blow holes
- Solder bridges

FUJIYAMA user interface



Extra Component Detection (ECD) inspection capability

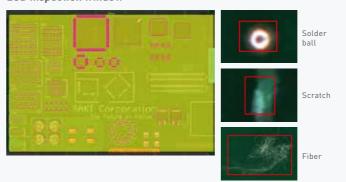
SAKI's Line Scan technology scans the entire PCB in one pass. By applying the ECD function, unexpected defects such as the following can be detected automatically:

production management systems and production lines.

- Plastic mold chipping
- Reel tape fragments
- PCB pattern defects
- Dropped chip parts
- Solder frame damage

• Foreign substances

ECD inspection window



SAKI QUALITY DRIVEN Factor 3 **Production Solution**

BF2 Integration

The new THT AOI adopts the same software platform as the 3D Solder Paste Inspection machine (SPI) and 3D Automated Optical Inspection machine (AOI) systems.

- Simple and easy user interface
- Effective defect judgement display
- Offline programming
- Statistical processing of inspection results

Additionally, by using the same system options as SAKI's SPI and AOI solutions, the operator's workload is reduced. Maintenance is easy and cost efficient since the same maintenance and service parts are used.

BF2-Monitor Image

